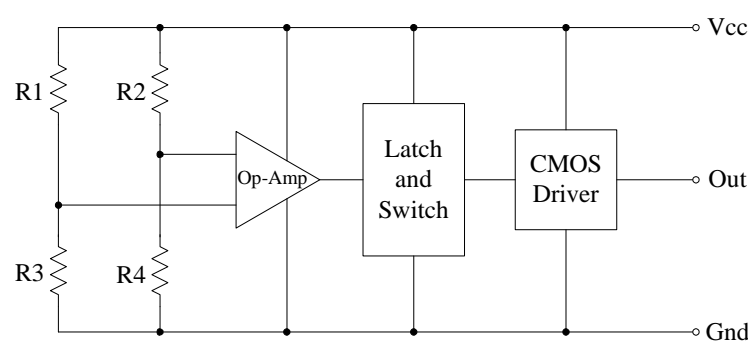


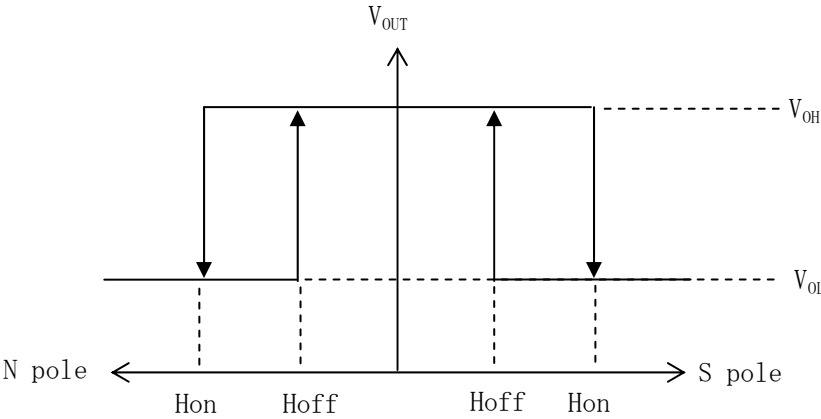
Reference mount pad

3-2 Block wiring diagram

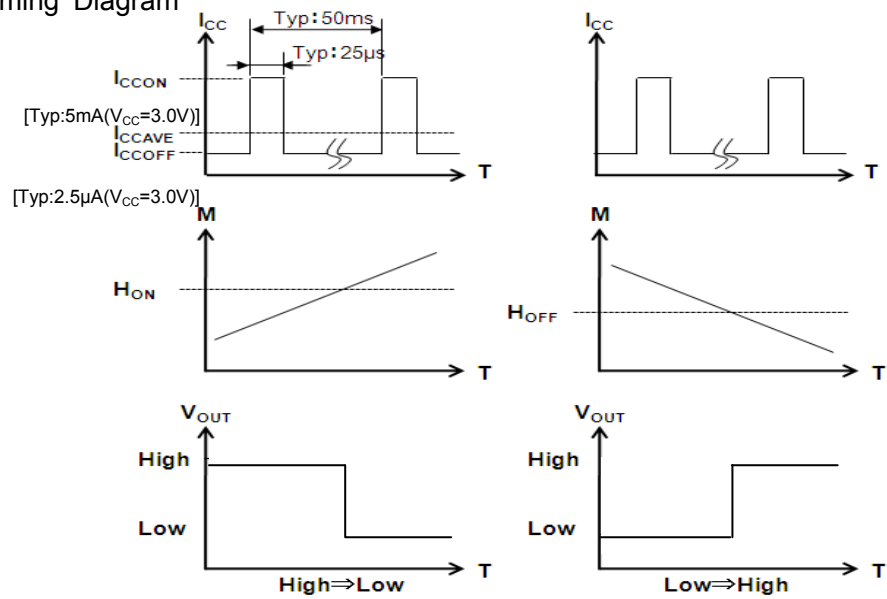


The intermittent switch circuit inside

3-3 Magnetic electric conversion characteristic



## 3-4 Timing Diagram



Magnetic Field Applied

Magnetic Field Released

3-5 Electric Characteristics/ Absolute Maximum Rating ( $T_a=+25^{\circ}C$   $V_{CC}=3.0V$ )

	Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
1	Supply voltage	$V_{CC}$	—	1.6	3.0	3.5	V
2	Absolute max. supply voltage	—	—	—	—	6.0	V
3	Current consumption	$I_{AVE}$	Average $V_{CC}=3.0V$	—	5	12	uA
4	Operating magnetic field	$H_{on}$	+25°C	—	—	2.5	mT
			-40~+85°C	—	—	3.0	
		$H_{off}$	+25°C	0.5	—	—	
			-40~+85°C	0.2	—	—	
5	Hi level output	$V_{OH}$	$I_{out}=+2mA$	2.7	—	—	V
6	Lo level output	$V_{OL}$	$I_{out}=-2mA$	—	—	0.3	V
7	Operating temp. range	—	—	-40	—	+85	°C
8	Storage temp. range	—	—	-40	—	+125	°C

NOTE1) Each specification is defined by testing above items individually.

NOTE2) When shifting the sensor output from H to L, please make sure the magnetic field applied to the sensor becomes higher than the above operating magnetic field ( $H_{on}$ ) through your designing.

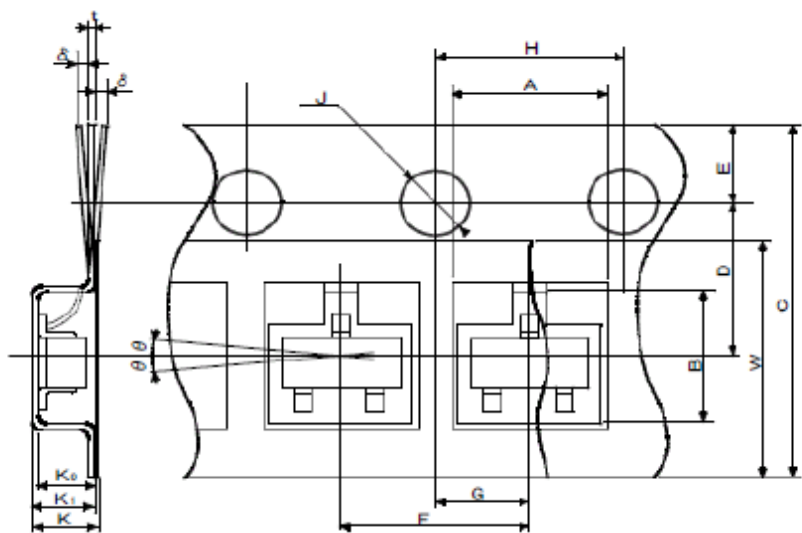
NOTE3) When shifting the sensor output from L to H, please make sure the magnetic field applied to the sensor becomes lower than the above operating magnetic field ( $H_{off}$ ) through your designing.

NOTE4) Sensitivity selection of this product is performed at  $V_{CC}=3.0V$ . Operating magnetic field can possibly change when applying the supply voltage other than 3.0V. Please consult with us for technical assistance when you consider the supply voltage other than 3.0V, as a special attention needs to be given in the design.

## 3-6 Packing information

Form of packing	Reel dimension	Pcs per reel
Tape & reel	φ180	3000pcs

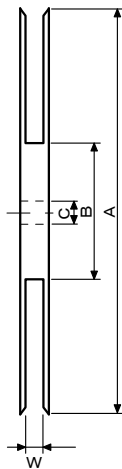
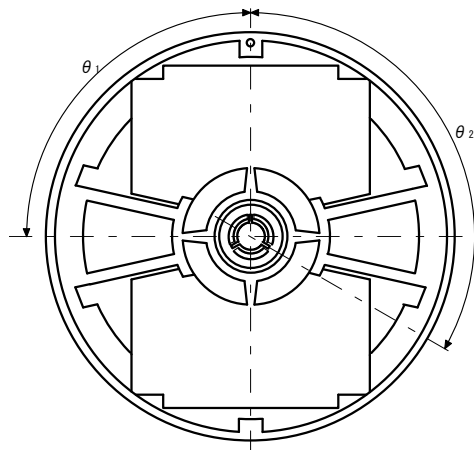
3-7 Taping specifications  
3-7-1 Taping dimensions



Unit:mm

Parameter		Symbol	Size/ Angle	Parameter		Symbol	Size/ Angle
Pocket	Length	A	3.35±0.1	Dist. Between center lines	L direction	G	2.0±0.05
	Width	B	3.2±0.1		W direction	D	3.5±0.05
	Depth	K <sub>0</sub>	1.4±0.1	Cover tape	Width	W	5.5 <sup>+0.3</sup> <sub>-0</sub>
	Pitch	F	4.0±0.1	Carrier tape	Width	C	8.0±0.1
Feed hole	Diameter	J	φ1.5 <sup>+0.1</sup> <sub>-0.05</sub>		Thickness	T	0.2±0.05
	Pitch	H	4.0±0.1		Depth	K <sub>1</sub>	1.5±0.1
	Position	E	1.75±0.1	Device	Tilt	θ	30°MAX
Overall thickness		K	1.55±0.1				

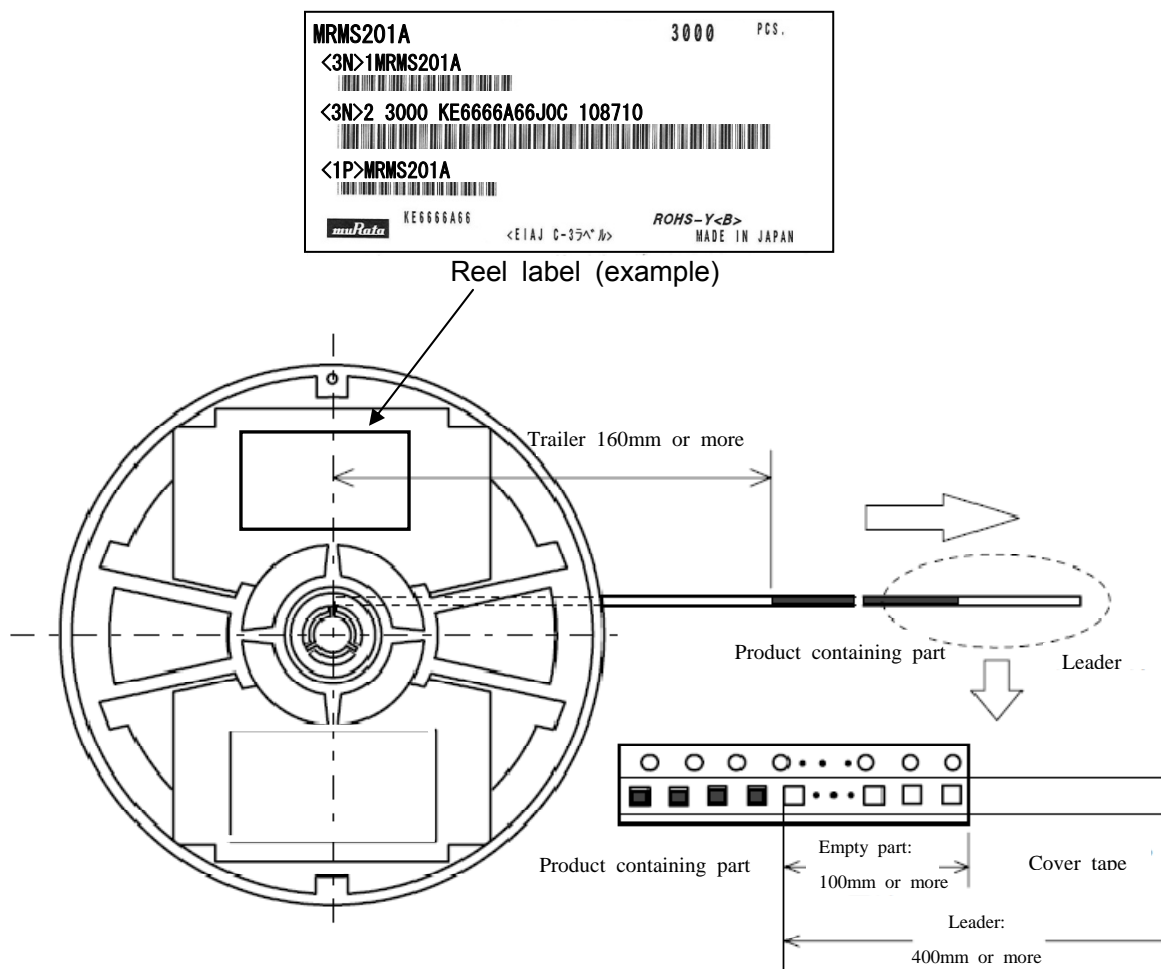
3-7-2 Reel dimensions...EIAJ PRV08B compliant



Unit: mm

Item	Symbol	Dim/Angle
Diameter	A	φ178±2
Dis. between flanges	W	9±0.5
Diameter	B	φ60±1
Hub slit position	θ <sub>1</sub>	90°
Spindle hole diam.	C	φ13±0.5
Key slit position	θ <sub>2</sub>	120°
Marking	Labeled on one side of flange	

## 3-7-3 Start/End of taping

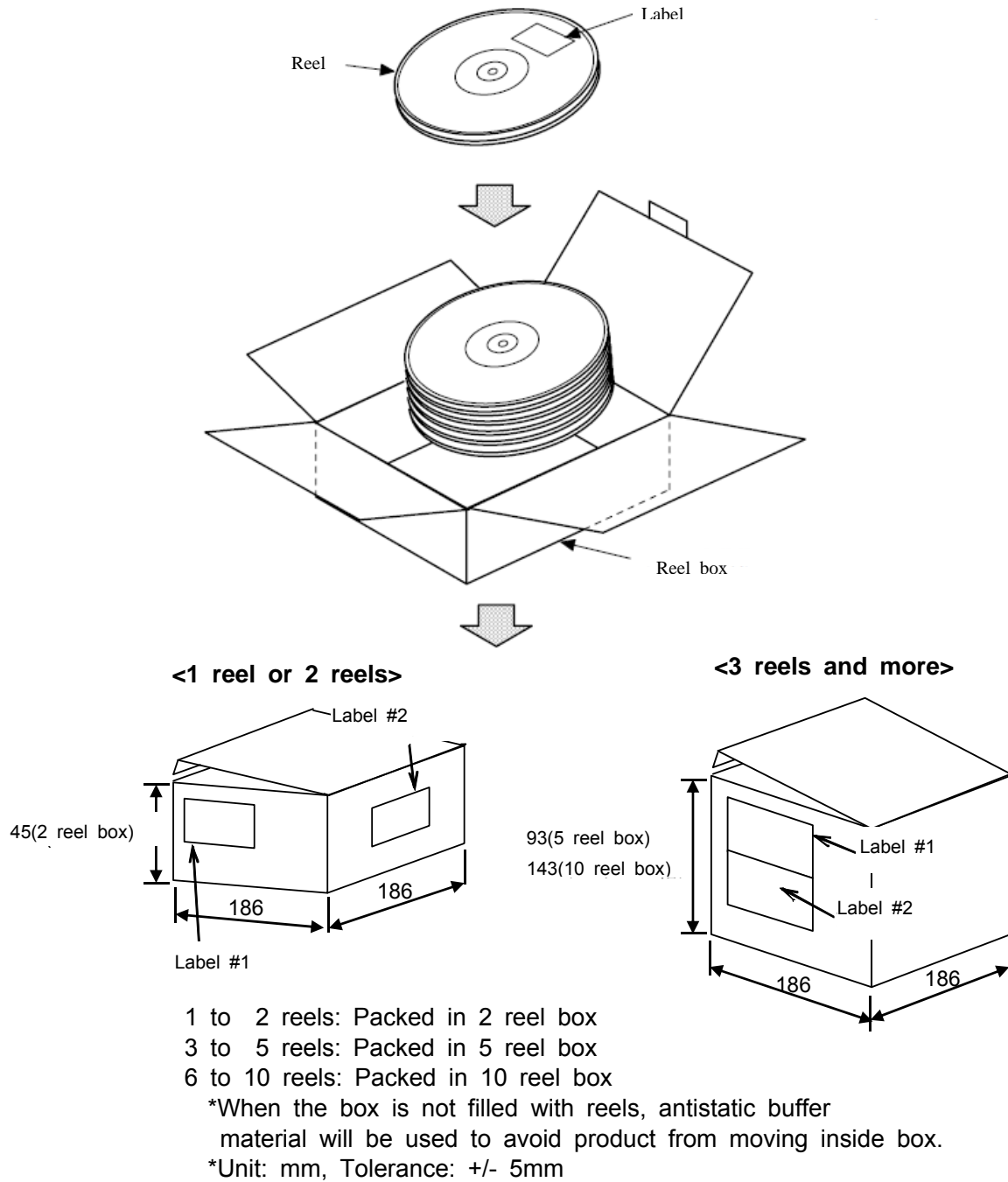


## 3-7-4 Other notes

Continuously missing device shall not exceed 2 pcs.

Peeling strength of the cover tape: 0.1 to 0.7N.

## 3.8 Outer packing specifications



発注者 <CUST.>	株式会社村田製作所	1L
受取場所 <DELIVERY POINT>	13/05/07 06	
部品キー番号 <TRANS. NO.>	TEST0003	MRSS21E
品名コード <PART NO.>	MRMS201A	200786 22-22222
品名 <PART NAME>		
入数/部品数量 <QTY/TOTAL QTY>	3,000/	3,000 単位 <UNIT> PC
発注者用備考 <CUSTOMER'S REMARKS>	包装単位 <PACKAGE COUNT> 001/001	

Label #1 (example)

(3N) 3TEST003 3000
(3N) 4MRMS201A 3000
(3N) 5 222030AYNM01
Murata
MURATA MANUFACTURING CO., LTD. MADE IN JAPAN

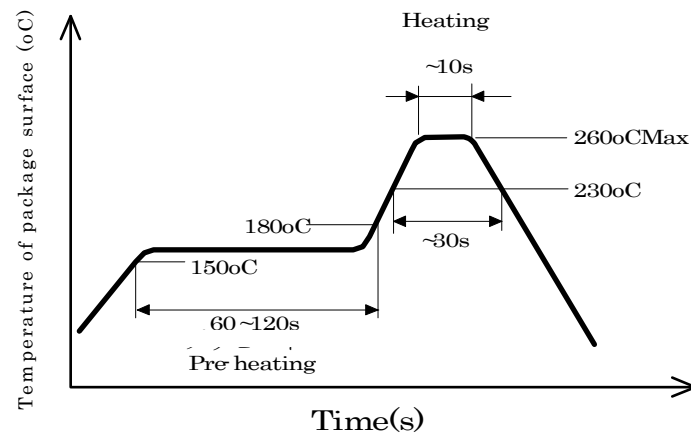
Label #2 (example)

Material

Reel packing box: Cardboard

## 4. Mounting condition

## 4-1 Reflow condition, Hand soldering condition



Times of reflow: 3 or less

Hand soldering condition:  $350 \pm 5^{\circ}\text{C}$ , within 3 sec/each terminal

## 4-2 Other

MSL(Moisture Sensitivity Level): equal to MSL1

## 5. Reliability test

No.	Reliability test	Test conditions	Judgment criteria
1	High temp. storage	+125°C 500h No-load	Satisfy the parameter 5 and 6 in 3-5.
2	Low temp. storage	-40 °C 500h No-load	
3	High temp, high humidity load	+85 °C 85%RH 500h Load voltage 3V	
4	Vibration	Apply vibration [Max amplitude:1.5mm, frequency: 10 to 55Hz, 1 cycle minute, 3 directions, 2h in each direction (total 6h )]	
5	Thermal shock	-55 °C/30 min⇔+125 °C/30min (vapor phase) 500 cycle, no-load	
6	Solder heat resistance	Pre treatment:+85 °C, 85%RH, 168h Reflow condition: Max. 260 °C & 230 °C,30 sec, times of reflow: 3	
7	Solderability	Solder temp.:+230 °C, Time: 3 sec immersion	90% and more terminal surface covered with solder
8	Electrostatic resistance	Machine Model Condition:200pF,Resistance:0Ω, +/-200V	Satisfy the parameter 5 and 6 in 3-5.
		Human Body Model Condition:100pF, Resistance: 1.5kΩ, +/-2kV	
9	Electrode sticking tendency	5N(510gf), 4 directions, 10 sec	Satisfy the parameter 5 and 6 in 3-5. No external abnormality found.
10	Drop test	100g dummy load, Height:150cm, on the concrete, 6 sides, 10 times/each	Satisfy the parameter 5 and 6 in 3-5.
11	Shock test	Unpacked condition, X, Y, Z direction, 1470m/s <sup>2</sup> , 5 times/each	
12	Bending cycle	Glass epoxy PCB (FR-4), t=1.0, Speed:5mm/min, 90mm span, 1mm Bend to + and – side, 1500 cycle	No terminal fracture, loosening found.
13	Bending limit	Glass epoxy PCB (FR-4), t=1.0, 90mm span, bend 7mm to + and –side.	

## 6. ⚠ CAUTION

### 6-1 Limitation of Applications

Please avoid using this product for the applications listed below which require especially high reliability in order to prevent defects that might directly cause damage to the third party's life, body, or property.

When this product is used for the applications listed below, we shall not be liable for any claims on the product.

- ① Aircraft equipment
- ② Aerospace equipment
- ③ Undersea equipment
- ④ Generating plant equipment
- ⑤ Medical equipment
- ⑥ Transportation equipment (vehicles, trains, ships, etc.)
- ⑦ Traffic signal equipment
- ⑧ Disaster prevention/ crime prevention equipment
- ⑨ Data processing equipment
- ⑩ Application of similar complexity and/or reliability requirements to the applications listed above.

### 6-2 FAIL-SAFE

Be sure to provide appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

## 7. CAUTION FOR USE

### 7-1 HANDLING

- This product may be degraded by electrostatic discharge. It is necessary to take anti-static precautions when handling.

### 7-2 DESIGN

- Please thoughtfully evaluate this product for the magneto-variation of the magnet used along with this product, otherwise this product may result in the miss-operation or the non-operation.
- Sensor miss-operation or non-operation may occur due to the influence of the magnetic noise from surrounding devices such as motor. Please make sure there is no influence of the magnetic noise in designing process.
- Please be careful about a magnetic body (Iron, Nickel, etc.) and a magnetic noise immunity that may affect the magnetism of a magnet.

Please do not supply inverse voltage or excess voltage to this product. If applied, this product may be damaged and electrically destroyed.



- Please design your product not to be affected by stress of the resin due to heat shrink.
- It is effective to make the Vcc and GND line wide and short or to adopt multi-layer PCB for switching noise protection. In addition, please place a bypass capacitor near the sensor.

### 7-3 Storage condition

- Recommended storage conditions are listed below.  
Temperature : +5 to +30°C  
Humidity : 70%(RH)% and lower  
\*Desiccator storage or storage in N<sub>2</sub> atmosphere is recommended.
- Allowable storage time of the product is one year from the date of delivery. Please take account of the storage conditions listed above. Please also use the product as soon as possible after opening the product packing to avoid the deterioration of solderability.
- Please avoid the water, chemical solvent, or oil.
- Please avoid the corrosive gas (Cl<sub>2</sub> H<sub>2</sub>S, NH<sub>3</sub> NO<sub>2</sub>, NO<sub>3</sub> etc.)
- Please avoid the strong vibration or shock.

### 7-4 Mounting

- Please mount this product under standard reflow condition. Otherwise this product may be damaged.
- Please do not apply excessive load to the terminals. Also, please do not bend the terminals.
- Please do not apply excessive bending stress to the product by bending the PCB or by similar handling as it may change the sensor sensitivity.

## 8. NOTE

- Make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- Not to use our product deviating from the agreed specification.
- We consider it not appropriate to include any terms and conditions with regard to the business transaction in the product specifications, drawings or other technical documents. Therefore, if your technical documents above include such terms and conditions such as warranty clause, product liability clause, or intellectual property infringement liability clause, they will be deemed to be invalid.